The EL5220T is a high voltage rail-to-rail input-output amplifier with low power consumption. The EL5220T contains two amplifiers. Each amplifier exhibits beyond the rail input capability, rail-to-rail output capability and is unity gain stable.

The maximum operating voltage range is from 4.5 V to 19 V . It can be configured for single or dual supply operation, and typically consumes only $550 \mu \mathrm{~A}$ per amplifier. The EL5220T has an output short circuit capability of $\pm 200 \mathrm{~mA}$ and a continuous output current capability of $\pm 65 \mathrm{~mA}$.
The EL5220T features a slew rate of $12 \mathrm{~V} / \mu \mathrm{s}$. Also, the device provides common mode input capability beyond the supply rails, rail-to-rail output capability, and a bandwidth of $12 \mathrm{MHz}(-3 \mathrm{~dB})$. This enables the amplifiers to offer maximum dynamic range at any supply voltage. These features make the EL5220T an ideal amplifier solution for use in TFT-LCD panels as a $\mathrm{V}_{\text {COM }}$ or static gamma buffer, and in high speed filtering and signal conditioning applications. Other applications include battery power and portable devices, especially where low power consumption is important.
The EL5220T is available in an 8 Ld MSOP package, and a thermally enhanced 8 Ld DFN package. Both feature a standard operational amplifier pinout. The devices operate over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

## Features

- $12 \mathrm{MHz}(-3 \mathrm{~dB})$ Bandwidth
- 4.5V to 19 V Maximum Supply Voltage Range
- $12 \mathrm{~V} / \mu \mathrm{s}$ Slew Rate
- 550 AA Supply Current (per Amplifier)
- $\pm 65 \mathrm{~mA}$ Continuous Output Current
- $\pm 200 \mathrm{~mA}$ Output Short Circuit Current
- Unity-gain Stable
- Beyond the Rails Input Capability
- Rail-to-rail Output Swing
- Built-in Thermal Protection
- $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ Ambient Temperature Range
- Pb-free (RoHS Compliant)


## Applications* (see page 13)

- TFT-LCD Panels
- $V_{\text {COM }}$ Amplifiers
- Static Gamma Buffers
- Electronics Notebooks
- Electronics Games
- Touch-screen Displays
- Personal Communication Devices
- Personal Digital Assistants (PDA)
- Portable Instrumentation
- Sampling ADC Amplifiers
- Wireless LANs
- Office Automation
- Active Filters
- ADC/DAC Buffer


FIGURE 1. TYPICAL TFT-LCD $\mathbf{V}_{\text {COM }}$ APPLICATION


FIGURE 2. FREQUENCY RESPONSE FOR VARIOUS $R_{L}$

## Pin Configuration



EL5220T
( 8 LD DFN)
TOP VIEW


CONNECTED TO VS-

## Pin Descriptions



## Ordering Information

| PART NUMBER <br> (Notes 2, 3) | PART <br> MARKING | PACKAGE <br> (Pb-Free) | PKG. <br> DWG. \# |
| :--- | :--- | :--- | :--- |
| EL5220TILZ-T13 (Note 1) | $20 T$ | 8 Ld DFN | L8.2x3 |
| EL5220TIYZ | BBBMA | 8 Ld MSOP | M8.118A |
| EL5220TIYZ-T7 (Note 1) | BBBMA | 8 Ld MSOP | M8.118A |
| EL5220TIYZ-T13 (Note 1) | BBBMA | 8 Ld MSOP | M8.118A |

NOTES:

1. Please refer to TB347 for details on reel specifications.
2. These Intersil Pb -free plastic packaged products employ special Pb -free material sets, molding compounds/die attach materials, and $100 \%$ matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb -free soldering operations). Intersil Pb -free products are MSL classified at Pb -free peak reflow temperatures that meet or exceed the Pb -free requirements of IPC/JEDEC J STD-020.
3. For Moisture Sensitivity Level (MSL), please see device information page for EL5220T. For more information on MSL please see techbrief TB363.


## Thermal Information

| Thermal Resistance (Typical) | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right) \theta_{\mathrm{JC}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: |
| 8 Ld MSOP (Notes 6, 7) | 17060 |
| 8 Ld DFN (Notes 4, 5) | 58 8 |
| Storage Temperature. | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Ambient Operating Tempera | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Maximum Junction Temperatur | $+150^{\circ} \mathrm{C}$ |
| Power Dissipation | See Figures 32 and 33 |
| Pb-Free Reflow Profile . . . . http://www.intersil.com/p | . . . . . . .see link below reeReflow.asp |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.
NOTES:
4. $\theta_{\mathrm{JA}}$ is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief TB379.
5. For $\theta_{\mathrm{JC}}$, the "case temp" location is the center of the exposed metal pad on the package underside.
6. $\theta_{\mathrm{JA}}$ is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.
7. For $\theta_{\mathrm{JC}}$, the "case temp" location is taken at the package top center.

## IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typ values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_{J}=T_{C}=T_{A}$

Electrical Specifications $\quad \mathrm{V}_{\mathrm{S}^{+}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}^{-}}=-5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ to $0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OS}}$ | Input Offset Voltage | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 3 | 18 | mV |
| TCV ${ }_{\text {OS }}$ | Average Offset Voltage Drift (Note 8) | 8 Ld MSOP package |  | 5 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
|  |  | 8 Ld DFN package |  | 3 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{I}_{\mathrm{B}}$ | Input Bias Current | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$ |  | 2 | 50 | nA |
| $\mathrm{R}_{\text {IN }}$ | Input Impedance |  |  | 1 |  | $\mathrm{G} \Omega$ |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 2 |  | pF |
| CMIR | Common-Mode Input Range |  | -5.5 |  | +5.5 | V |
| CMRR | Common-Mode Rejection Ratio | For $\mathrm{V}_{\text {INX }}$ from -5.5 V to +5.5 V | 50 | 75 |  | dB |
| AVOL | Open Loop Gain | $-4.5 \mathrm{~V} \leq \mathrm{V}_{\text {OUTx }} \leq+4.5 \mathrm{~V}$ | 75 | 105 |  | dB |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{V}_{\text {OL }}$ | Output Swing Low | $\mathrm{I}_{\mathrm{L}}=-5 \mathrm{~mA}$ |  | -4.94 | -4.85 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Output Swing High | $\mathrm{I}_{\mathrm{L}}=+5 \mathrm{~mA}$ | 4.85 | 4.94 |  | V |
| ISC | Short Circuit Current | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$, Source: $\mathrm{V}_{\text {OUTx }}$ short to $\mathrm{V}_{\mathrm{S}^{-}}$, <br> Sink: $\mathrm{V}_{\text {OUTx }}$ short to $\mathrm{V}_{\mathrm{S}}{ }^{+}$ |  | $\pm 200$ |  | mA |
| IOUT | Output Current |  |  | $\pm 65$ |  | mA |
| POWER SUPPLY PERFORMANCE |  |  |  |  |  |  |
| $\left(\mathrm{V}_{\mathrm{S}^{+}}\right)-\left(\mathrm{V}_{\mathrm{S}^{-}}\right)$ | Supply Voltage Range |  | 4.5 |  | 19 | V |
| Is | Supply Current (Per Amplifier) | $\mathrm{V}_{\mathrm{CM}}=0 \mathrm{~V}$, No load |  | 550 | 750 | $\mu \mathrm{A}$ |
| PSRR | Power Supply Rejection Ratio | Supply is moved from $\pm 2.25 \mathrm{~V}$ to $\pm 9.5 \mathrm{~V}$ | 60 | 75 |  | dB |

Electrical Specifications $\mathrm{V}_{S^{+}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}^{-}}=-5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ to $0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified. (Continued)

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE |  |  |  |  |  |  |
| SR | Slew Rate (Note 9) | $-4.0 \mathrm{~V} \leq \mathrm{V}_{\text {OUTx }} \leq+4.0 \mathrm{~V}, 20 \%$ to $80 \%$ |  | 12 |  | V/us |
| $\mathrm{t}_{S}$ | Settling to $+0.1 \%$ (Note 10) | $\begin{aligned} & A_{V}=+1, V_{\text {OUTX }}=2 V \text { step, } \\ & R_{L}=10 \mathrm{k} \Omega, C_{L}=8 p F \end{aligned}$ |  | 500 |  | ns |
| BW | -3dB Bandwidth | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=8 \mathrm{pF}$ |  | 12 |  | MHz |
| GBWP | Gain-Bandwidth Product | $\begin{aligned} & A_{V}=-50, R_{F}=5 \mathrm{k} \Omega, R_{G}=100 \Omega \\ & R_{L}=10 \mathrm{k} \Omega, C_{L}=8 \mathrm{pF} \end{aligned}$ |  | 8 |  | MHz |
| PM | Phase Margin | $\begin{aligned} & A_{V}=-50, R_{F}=5 \mathrm{k} \Omega, R_{G}=100 \Omega \\ & R_{L}=10 \mathrm{k} \Omega, C_{L}=8 \mathrm{pF} \end{aligned}$ |  | 50 |  | - |
| CS | Channel Separation | $\mathrm{f}=5 \mathrm{MHz}$ |  | 85 |  | dB |

Electrical Specifications $\quad \mathrm{V}_{\mathrm{S}^{+}}=+5 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}^{-}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ to $2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OS}}$ | Input Offset Voltage | $\mathrm{V}_{\mathrm{CM}}=2.5 \mathrm{~V}$ |  | 3 | 18 | mV |
| TCV ${ }_{\text {OS }}$ | Average Offset Voltage Drift (Note 8) | 8 Ld MSOP package |  | 5 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
|  |  | 8 Ld DFN package |  | 3 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{I}_{\mathrm{B}}$ | Input Bias Current | $\mathrm{V}_{\mathrm{CM}}=2.5 \mathrm{~V}$ |  | 2 | 50 | nA |
| $\mathrm{R}_{\text {IN }}$ | Input Impedance |  |  | 1 |  | $\mathrm{G} \Omega$ |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 2 |  | pF |
| CMIR | Common-Mode Input Range |  | -0.5 |  | +5.5 | V |
| CMRR | Common-Mode Rejection Ratio | For $\mathrm{V}_{\text {INx }}$ from -0.5 V to +5.5 V | 45 | 70 |  | dB |
| AVol | Open Loop Gain | $0.5 \mathrm{~V} \leq \mathrm{V}_{\text {OUTX }} \leq+4.5 \mathrm{~V}$ | 75 | 105 |  | dB |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Output Swing Low | $\mathrm{I}_{\mathrm{L}}=-2.5 \mathrm{~mA}$ |  | 30 | 150 | mV |
| $\mathrm{V}_{\mathrm{OH}}$ | Output Swing High | $\mathrm{I}_{\mathrm{L}}=+2.5 \mathrm{~mA}$ | 4.85 | 4.97 |  | V |
| $\mathrm{I}_{\text {SC }}$ | Short Circuit Current | $\mathrm{V}_{\mathrm{CM}}=2.5 \mathrm{~V}$, Source: $\mathrm{V}_{\text {OUTX }}$ short to $\mathrm{V}_{\mathrm{S}^{-}}$, <br> Sink: $\mathrm{V}_{\text {OUTx }}$ short to $\mathrm{V}_{\mathrm{S}^{+}}$ |  | $\pm 125$ |  | mA |
| IOUT | Output Current |  |  | $\pm 65$ |  | mA |

## POWER SUPPLY PERFORMANCE

| $\left(\mathrm{V}_{\mathrm{S}^{+}}\right)-\left(\mathrm{V}_{\mathrm{S}^{-}}\right)$ | Supply Voltage Range |  | 4.5 |  | 19 | V |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{IS}_{\mathrm{S}}$ | Supply Current (Per Amplifier) | $\mathrm{V}_{\mathrm{CM}}=2.5 \mathrm{~V}$, No load |  | 550 | 750 | $\mu \mathrm{~A}$ |
| PSRR | Power Supply Rejection Ratio | Supply is moved from 4.5V to 19 V | 60 | 75 |  | dB |

## DYNAMIC PERFORMANCE

| SR | Slew Rate (Note 9) | $1 \mathrm{~V} \leq \mathrm{V}_{\mathrm{OUTx}} \leq 4 \mathrm{~V}, 20 \%$ to $80 \%$ |  | 12 |  |
| :---: | :--- | :--- | :---: | :---: | :---: |
| tS | Settling to $+0.1 \%$ (Note 10) | $\mathrm{A}_{\mathrm{V}}=+1, \mathrm{~V}_{\mathrm{OUTx}}=2 \mathrm{~V}$ step, <br> $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=8 \mathrm{pF}$ | Ns |  |  |
| BW | -3dB Bandwidth | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=8 \mathrm{pF}$ | 500 | ns |  |
| GBWP | Gain-Bandwidth Product | $\mathrm{A}_{\mathrm{V}}=-50, \mathrm{R}_{\mathrm{F}}=5 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{G}}=100 \Omega$ <br> $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=8 \mathrm{pF}$ |  | 12 | MHz |
| PM | Phase Margin | $\mathrm{A}_{\mathrm{V}}=-50, \mathrm{R}_{\mathrm{F}}=5 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{G}}=100 \Omega$ <br> $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=8 \mathrm{pF}$ | 8 | MHz |  |
| CS | Channel Separation | $\mathrm{f}=5 \mathrm{MHz}$ | 50 | $\circ$ |  |

Electrical Specifications $\mathrm{V}_{\mathrm{S}^{+}}=+18 \mathrm{~V}, \mathrm{~V}_{\mathrm{S}^{-}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ to $9 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise specified.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OS}}$ | Input Offset Voltage | $\mathrm{V}_{\mathrm{CM}}=9 \mathrm{~V}$ |  | 5 | 18 | mV |
| TCV ${ }_{\text {OS }}$ | Average Offset Voltage Drift (Note 8) | 8 Ld MSOP package |  | 6 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
|  |  | 8 Ld DFN package |  | 4 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| IB | Input Bias Current | $\mathrm{V}_{\mathrm{CM}}=9 \mathrm{~V}$ |  | 2 | 50 | nA |
| $\mathrm{R}_{\text {IN }}$ | Input Impedance |  |  | 1 |  | $\mathrm{G} \Omega$ |
| $\mathrm{C}_{\text {IN }}$ | Input Capacitance |  |  | 2 |  | pF |
| CMIR | Common-Mode Input Range |  | -0.5 |  | +18.5 | V |
| CMRR | Common-Mode Rejection Ratio | For $\mathrm{V}_{\text {INx }}$ from -0.5 V to +18.5 V | 53 | 78 |  | dB |
| AVOL | Open Loop Gain | $0.5 \mathrm{~V} \leq \mathrm{V}_{\text {OUTx }} \leq 17.5 \mathrm{~V}$ | 75 | 90 |  | dB |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |
| $\mathrm{V}_{\text {OL }}$ | Output Swing Low | $\mathrm{I}_{\mathrm{L}}=-9 \mathrm{~mA}$ |  | 120 | 150 | mV |
| $\mathrm{V}_{\mathrm{OH}}$ | Output Swing High | $\mathrm{I}_{\mathrm{L}}=+9 \mathrm{~mA}$ | 17.85 | 17.88 |  | V |
| ISC | Short Circuit Current | $\mathrm{V}_{\mathrm{CM}}=9 \mathrm{~V}$, Source: $\mathrm{V}_{\text {OUTx }}$ short to $\mathrm{V}_{\mathrm{S}^{-}}$, <br> Sink: $\mathrm{V}_{\text {OUTX }}$ short to $\mathrm{V}_{\mathrm{S}^{+}}$ |  | $\pm 200$ |  | mA |
| IOUT | Output Current |  |  | $\pm 65$ |  | mA |
| POWER SUPPLY PERFORMANCE |  |  |  |  |  |  |
| $\left(\mathrm{V}_{\mathrm{S}^{+}}\right)-\left(\mathrm{V}_{\mathrm{S}^{-}}\right)$ | Supply Voltage Range |  | 4.5 |  | 19 | V |
| Is | Supply Current (Per Amplifier) | $\mathrm{V}_{\mathrm{CM}}=9 \mathrm{~V}$, No load |  | 650 | 850 | $\mu \mathrm{A}$ |
| PSRR | Power Supply Rejection Ratio | Supply is moved from 4.5 V to 19 V | 60 | 75 |  | dB |
| DYNAMIC PERFORMANCE |  |  |  |  |  |  |
| SR | Slew Rate (Note 9) | $1 \mathrm{~V} \leq \mathrm{V}_{\text {OUTx }} \leq 17 \mathrm{~V}, 20 \%$ to $80 \%$ |  | 12 |  | $\mathrm{V} / \mathrm{\mu s}$ |
| ts | Settling to $+0.1 \%$ (Note 10) | $\begin{aligned} & A_{V}=+1, V_{\text {OUTX }}=2 V \text { step, } \\ & R_{L}=10 \mathrm{k} \Omega, C_{L}=8 p F \end{aligned}$ |  | 500 |  | ns |
| BW | -3dB Bandwidth | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=8 \mathrm{pF}$ |  | 12 |  | MHz |
| GBWP | Gain-Bandwidth Product | $\begin{aligned} & A_{V}=-50, R_{F}=5 \mathrm{k} \Omega, R_{G}=100 \Omega \\ & R_{L}=10 \mathrm{k} \Omega, C_{L}=8 \mathrm{pF} \end{aligned}$ |  | 8 |  | MHz |
| PM | Phase Margin | $\begin{aligned} & A_{V}=-50, R_{F}=5 \mathrm{k} \Omega, R_{G}=100 \Omega \\ & R_{L}=10 \mathrm{k} \Omega, C_{L}=8 \mathrm{pF} \end{aligned}$ |  | 50 |  | 。 |
| CS | Channel Separation | $\mathrm{f}=5 \mathrm{MHz}$ |  | 85 |  | dB |

NOTES:
8. Measured over $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ambient operating temperature range. See the typical $T C V_{O S}$ production distribution shown in the "Typical Performance Curves" on page 6.
9. Typical slew rate is an average of the slew rates measured on the rising ( $20 \%$ to $80 \%$ ) and the falling ( $80 \%$ to $20 \%$ ) edges of the output signal.
10. Settling time measured as the time from when the output level crosses the final value on rising/falling edge to when the output level settles within a $\pm 0.1 \%$ error band. The range of the error band is determined by: Final Value $(\mathrm{V}) \pm[$ Full $\operatorname{Scale}(\mathrm{V}) * 0.1 \%]$

## Typical Performance Curves



FIGURE 3. INPUT OFFSET VOLTAGE DISTRIBUTION


FIGURE 5. INPUT OFFSET VOLTAGE DRIFT (DFN)


FIGURE 7. INPUT BIAS CURRENT vs TEMPERATURE


FIGURE 4. INPUT OFFSET VOLTAGE DRIFT (MSOP)


FIGURE 6. INPUT OFFSET VOLTAGE vs TEMPERATURE


FIGURE 8. OUTPUT HIGH VOLTAGE vs TEMPERATURE

## Typical Performance Curves (Continued)



FIGURE 9. OUTPUT LOW VOLTAGE vs TEMPERATURE


FIGURE 11. SLEW RATE vs TEMPERATURE


FIGURE 13. SUPPLY CURRENT PER AMPLIFIER vs SUPPLY VOLTAGE


FIGURE 10. OPEN-LOOP GAIN vs TEMPERATURE


FIGURE 12. SUPPLY CURRENT PER AMPLIFIER vs TEMPERATURE


FIGURE 14. SLEW RATE vs SUPPLY VOLTAGE

## Typical Performance Curves (Continued)



FIGURE 15. OPEN LOOP GAIN AND PHASE vs FREQUENCY


FIGURE 17. FREQUENCY RESPONSE FOR VARIOUS CL


FIGURE 19. MAXIMUM OUTPUT SWING vs FREQUENCY


FIGURE 16. FREQUENCY RESPONSE FOR VARIOUS $\mathbf{R}_{\mathbf{L}}$


FIGURE 18. CLOSED LOOP OUTPUT IMPEDANCE vs FREQUENCY


FIGURE 20. CMRR vs FREQUENCY

## Typical Performance Curves (Continued)



FIGURE 21. PSRR vs FREQUENCY


FIGURE 23. TOTAL HARMONIC DISTORTION + NOISE vs FREQUENCY


FIGURE 25. SMALL SIGNAL OVERSHOOT vs LOAD CAPACITANCE


FIGURE 22. INPUT VOLTAGE NOISE SPECTRAL DENSITY vs FREQUENCY


FIGURE 24. CHANNEL SEPARATION vs FREQUENCY RESPONSE


FIGURE 26. STEP SIZE vs SETTLING TIME

Page 9 of 15

## Typical Performance Curves (Continued)



FIGURE 27. LARGE SIGNAL TRANSIENT RESPONSE


FIGURE 28. SMALL SIGNAL TRANSIENT RESPONSE

EL5220T


FIGURE 29. BASIC TEST CIRCUIT

## Applications Information

## Product Description

The EL5220T is a high voltage rail-to-rail input-output amplifier with low power consumption. The EL5220T contains two amplifiers. Each amplifier exhibits beyond the rail input capability, rail-to-rail output capability, and is unity gain stable.

The EL5220T features a slew rate of $12 \mathrm{~V} / \mu \mathrm{s}$. Also, the device provides common mode input capability beyond the supply rails, rail-to-rail output capability, and a bandwidth of $12 \mathrm{MHz}(-3 \mathrm{~dB})$. This enables the amplifiers to offer maximum dynamic range at any supply voltage.

## Operating Voltage, Input and Output Capability

The EL5220T can operate on a single supply or dual supply configuration. The EL5220T operating voltage ranges from a minimum of 4.5 V to a maximum of 19 V . This range allows for a standard 5 V (or $\pm 2.5 \mathrm{~V}$ ) supply voltage to dip to $-10 \%$, or a standard 18 V (or $\pm 9 \mathrm{~V}$ ) to rise by $+5.5 \%$ without affecting performance or reliability.

The input common-mode voltage range of the EL5220T extends 500 mV beyond the supply rails. Also, the EL5220T is immune to phase reversal. However, if the common mode input voltage exceeds the supply voltage by more than 0.5 V , electrostatic protection diodes in the input stage of the device begin to conduct. Even though phase reversal will not occur, to maintain optimal reliability it is suggested to avoid input overvoltage conditions. Figure 30 shows the input voltage driven 500 mV beyond the supply rails and the device output swinging between the supply rails.
The EL5220T output typically swings to within 50 mV of positive and negative supply rails with load currents of $\pm 5 \mathrm{~mA}$. Decreasing load currents will extend the output voltage range even closer to the supply rails. Figure 31 shows the input and output waveforms for the device in a unity-gain configuration. Operation is from $\pm 5 \mathrm{~V}$ supply with a $10 \mathrm{k} \Omega$ load connected to GND. The input is a $10 \mathrm{~V}_{\mathrm{p}-\mathrm{p}}$ sinusoid and the output voltage is approximately $9.9 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$.

Refer to the "Electrical Specifications" Table beginning on page 3 for specific device parameters. Parameter variations with operating voltage, loading and/or temperature are shown in the "Typical Performance Curves" on page 6.


FIGURE 30. OPERATION WITH BEYOND-THE-RAILS INPUT


FIGURE 31. OPERATION WITH RAIL-TO-RAIL INPUT AND OUTPUT

## Output Current

The EL5220T is capable of output short circuit currents of 200 mA (source and sink), and the device has built-in protection circuitry which limits the output current to $\pm 200 \mathrm{~mA}$ (typical).

To maintain maximum reliability the continuous output current should never exceed $\pm 65 \mathrm{~mA}$. This $\pm 65 \mathrm{~mA}$ limit is determined by the characteristics of the internal metal interconnects. Also, see "Power Dissipation" on page 12 for detailed information on ensuring proper device operation and reliability for temperature and load conditions.

## Unused Amplifiers

It is recommended that any unused amplifiers be configured as a unity gain follower. The inverting input should be directly connected to the output and the non-inverting input tied to the ground.

## Thermal Shutdown

The EL5220T has a built-in thermal protection which ensures safe operation and prevents internal damage to the device due to overheating. When the die temperature reaches $+165^{\circ} \mathrm{C}$ (typical) the device automatically shuts OFF the outputs by putting them in a high impedance state. When the die cools by $+15^{\circ} \mathrm{C}$
(typical) the device automatically turns ON the outputs by putting them in a low impedance (normal) operating state.

## Driving Capacitive Loads

As load capacitance increases, the -3 dB bandwidth will decrease and peaking can occur. Depending on the application, it may be necessary to reduce peaking and to improve device stability. To improve device stability, a snubber circuit or a series resistor may be added to the output of the EL5220T.

A snubber is a shunt load consisting of a resistor in series with a capacitor. An optimized snubber can improve the phase margin and the stability of the EL5220T. The advantage of a snubber circuit is that it does not draw any DC load current or reduce the gain.

Another method to reduce peaking is to add a series output resistor (typically between $1 \Omega$ to $10 \Omega$ ). Depending on the capacitive loading, a small value resistor may be the most appropriate choice to minimize any reduction in gain.

## Power Dissipation

With the high-output drive capability of the EL5220T amplifiers, it is possible to exceed the $+150^{\circ} \mathrm{C}$ absolute maximum junction temperature under certain load current conditions. It is important to calculate the maximum power dissipation of the EL5220T in the application. Proper load conditions will ensure that the EL5220T junction temperature stays within a safe operating region.

The maximum power dissipation allowed in a package is determined according to Equation 1:
$P_{\text {DMAX }}=\frac{T_{J M A X}-T_{\text {AMAX }}}{\theta_{J A}}$
where:

- TJmax $=$ Maximum junction temperature
- TAMAX $^{\text {A Maximum ambient temperature }}$
- $\theta_{\mathrm{JA}}=$ Thermal resistance of the package
- PDMAX $=$ Maximum power dissipation allowed

The total power dissipation produced by an IC is the total quiescent supply current times the total power supply voltage, plus the power dissipation in the IC due to the loads, or:
$P_{\text {DMAX }}=\Sigma i\left[V_{S} \times I_{S M A X}+\left(V_{S}+-V_{\text {OUT }}{ }^{i}\right) \times I_{\text {LOAD }}{ }^{i}\right]$
when sourcing, and:

$$
\begin{equation*}
\mathrm{P}_{\text {DMAX }}=\Sigma \mathrm{i}\left[\mathrm{~V}_{\mathrm{S}} \times \mathrm{I}_{\text {SMAX }}+\left(\mathrm{V}_{\text {OUT }}{ }^{\left.\left.\mathrm{i}-\mathrm{V}_{\mathrm{S}^{-}}\right) \times \mathrm{I}_{\text {LOAD }} \mathrm{i}\right]}\right.\right. \tag{EQ.3}
\end{equation*}
$$

- $\mathrm{V}_{\mathrm{S}}=$ Total supply voltage $\left(\mathrm{V}_{\mathrm{S}^{+}}-\mathrm{V}_{\mathrm{S}^{-}}\right)$
- $\mathrm{V}_{\mathrm{S}^{+}}=$Positive supply voltage
- $\mathrm{V}_{\mathrm{S}^{-}}=$Negative supply voltage
- ISMAX $=$ Maximum supply current per amplifier (ISMAX $=$ EL5220T quiescent current $\div 2$ )
- $\mathrm{V}_{\text {OUT }}=$ Output voltage
- $\mathrm{I}_{\text {LOAD }}=$ Load current

Device overheating can be avoided by calculating the minimum resistive load condition, RLOAD, resulting in the highest power dissipation. To find R LOAD set the two PDMAX equations equal to each other and solve for $V_{\text {OUT }} / I_{\text {LOAD }}$. Reference the package power dissipation curves, Figures 32 and 33, for further information.


FIGURE 32. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

when sinking, where:

[^0]
## Power Supply Bypassing and Printed Circuit Board Layout

The EL5220T can provide gain at high frequency, so good printed circuit board layout is necessary for optimum performance. Ground plane construction is highly recommended, trace lengths should be as short as possible and the power supply pins must be well bypassed to reduce any risk of oscillation.

For normal single supply operation (the $\mathrm{V}_{\mathrm{S}^{-}}$pin is connected to ground) a $4.7 \mu \mathrm{~F}$ capacitor should be placed from $\mathrm{V}_{\mathrm{S}}+$ to ground, then a parallel $0.1 \mu \mathrm{~F}$ capacitor should be connected as close to the amplifier
as possible. One $4.7 \mu \mathrm{~F}$ capacitor may be used for multiple devices. For dual supply operation the same capacitor combination should be placed at each supply pin to ground.

It is highly recommended that EL5220T exposed thermal pad packages should always have the pad connected to the lowest potential, $\mathrm{V}_{\mathrm{S}^{-}}$, to optimize thermal and operating performance. PCB vias should be placed below the device's exposed thermal pad to transfer heat to the $\mathrm{V}_{\mathrm{S}^{-}}$plane and away from the device.

## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest Rev.

| DATE | REVISION |  |
| :---: | :---: | :--- |
| $5 / 4 / 10$ | FN6892.0 | Initial Release |

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## Package Outline Drawing

## M8.118A

8 LEAD MINI SMALL OUTLINE PLASTIC PACKAGE (MSOP) Rev 0, 9/09


TOP VIEW


SIDE VIEW 1


TYPICAL RECOMMENDED LAND PATTERN


DETAIL "X"

NOTES:

1. Dimensions are in millimeters.
2. Dimensioning and tolerancing conform to JEDEC MO-187-AA and AMSE Y14.5m-1994.
3. Plastic or metal protrusions of $\mathbf{0 . 1 5 m m}$ max per side are not included.
4. Plastic interlead protrusions of 0.25 mm max per side are not included.
5. Dimensions "D" and "E1" are measured at Datum Plane "H".
6. This replaces existing drawing \# MDP0043 MSOP 8L.

## Package Outline Drawing

## L8.2x3

## 8 LEAD DUAL FLAT NO-LEAD PLASTIC PACKAGE

Rev 1, 3/10


TOP VIEW


TYPICAL RECOMMENDED LAND PATTERN


BOTTOM VIEW


DETAIL "X"
NOTES:

1. Dimensions are in millimeters.

Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal $\pm 0.05$
4. Dimension applies to the metallized terminal and is measured between 0.25 mm and 0.30 mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature.
6. The configuration of the pin \#1 identifier is optional, but must be located within the zone indicated. The pin \#1 identifier may be either a mold or mark feature.
7. Compies to JEDEC MO-229 VCED-2.

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[^0]:    - $\mathrm{i}=1$ to 2
    (1, 2 corresponds to Channel A, B respectively)

